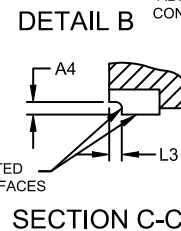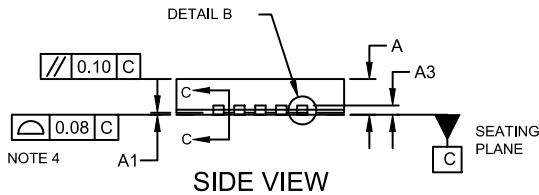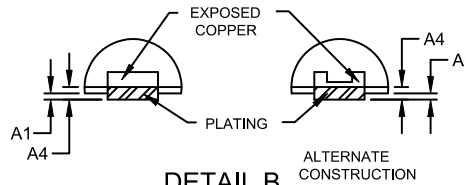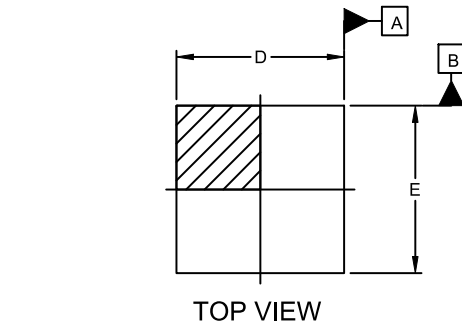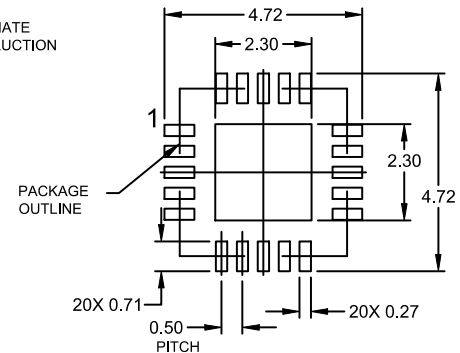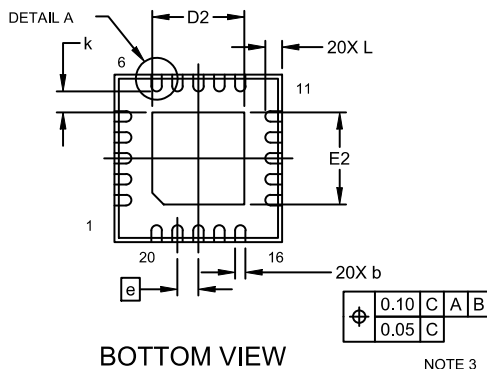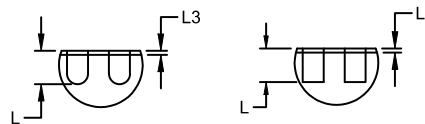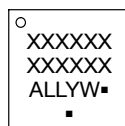**QFNW20 4x4, 0.5P**
CASE 484AP
ISSUE A

DATE 03 JUL 2018

NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.

2. CONTROLLING DIMENSION: MILLIMETERS

3. DIMENSION b APPLIES TO THE PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 FROM THE TERMINAL TIP.

4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

TOP VIEW

DETAIL B

SIDE VIEW

SECTION C-C

DETAIL A

BOTTOM VIEW

NOTE 3

RECOMMENDED MOUNTING FOOTPRINT

DIM	MILLIMETERS		
	MIN.	NOM.	MAX.
A	0.80	0.85	0.90
A1	---	---	0.05
A3	0.20 REF		
A4	0.10	---	---
b	0.20	0.25	0.30
D	3.90	4.00	4.10
D2	2.10	2.20	2.30
E	3.90	4.00	4.10
E2	2.10	2.20	2.30
e	0.50 BSC		
k	0.50 REF		
L	0.30	0.40	0.50
L3	0.05 REF		

GENERIC MARKING DIAGRAM*

XXXXXX = Specific Device Code
A = Assembly Location
LL = Wafer Lot
Y = Year
W = Work Week
▪ = Pb−Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb−Free indicator, "G" or microdot " ▪", may or may not be present.

(Note: Microdot may be in either location)

DOCUMENT NUMBER:	98AON91716G		
DESCRIPTION:	QFNW20 4x4, 0.5P		PAGE 1 OF 1